| ASSOCIATION CONNECTING<br>ASSOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES®<br>international and Pa | IPC. Bannockt   | ourn. Illinois. A        | Il rights reserved un ntions. | nder both               | This docume<br>level parts, t   | ent is a declaration er | on of the subs<br>acompasses a | tances with<br>ll lower lev | nin the manufacture<br>el materials for wh | er listed i<br>hich the n       | em. Note: if<br>nanufacturer | f the item is an as<br>has engineering | sembly with low responsibility. |
|---|-----------------|--------------------------|-------------------------------|-------------------------|---|-------------------------|--------------------------------|-----------------------------|--|---------------------------------|------------------------------|--|---------------------------------|
|   |                 |                          |                               | Form Type<br>Distribute | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materials |                         |                                |                             | als and M                                  | s and Mfg Information           |                              |  |                                 |
| Supplier Information  |                 |                          |                               |                         |   |                         |                                |                             |  |                                 |                              |  |                                 |
| Company name* Co  |                 |                          | Company unique ID             |                         |   | Unique ID Authority     |                                |                             |  | Response Date*                  |                              |  |                                 |
| onsemi  |                 |                          |                               |                         |   |                         |                                |                             |  | 2024-05-03                      |                              |  |                                 |
| Contact Name Title - Contact  |                 |                          | ct                            | Phe                     |   |                         | Phone - Contact*               |                             |  | Email - Contact*                |                              |  |                                 |
| Product-Env-Stewards Product Env  |                 |                          | ct Enviro Compliance          |                         |   | NA                      |                                |                             |  | Product-Env-Stewards@onsemi.com |                              |  |                                 |
| Authorized Representative* Title - Repr   |                 |                          | Representative                |                         |   | Phone - Representative* |                                |                             | Email - Representative*                    |                                 |                              |  |                                 |
| Product-Env-Stewards Pro  |                 |                          | Product Enviro Compliance     |                         |   | NA                      |                                |                             |  | Product-Env-Stewards@onsemi.com |                              |  |                                 |
| Requester Item Number   | Mfr Item Number |                          | er Mfr Item Name              |                         |   | Effective Date          | Version                        | Manı                        | Manufacturing Site                         |                                 | Weight*                      | UOM                                    | Unit Type                       |
|   | MC1451          | MC14511BDWR2G LOG CMOS D |                               | LY DCODE DI             | Y DCODE DRVR  |                         |                                | PH1                         | PH1  |                                 | 422.01                       | mg                                     | Each                            |
| Anufacturing Proccess Informa   | ition           |                          |                               |                         |   |                         |                                |                             |  |                                 |                              |  | ·                               |
| Terminal Plating / Grid Array Material Terminal Base Alloy  |                 | Alloy J                  | -STD-020 MSL                  | . Rating                | Peak Proce  | ss Body Tem             | perature N                     | Max Time at Peak            | Temperat                                   | ure Numb                        | er of Reflow Cyd             | cles                                   |                                 |
| Matte Tin (Sn) - annealed CU Alloy 3  |                 |                          |                               |                         | 260   | C                       | 3                              | 30                          | secon                                      | ds 3                            |                              |  |                                 |
| omments   |                 |                          |                               |                         |   |                         |                                |                             |  |                                 |                              |  |                                 |
| TTENTION: MSL 3 Rated item require  | es Bake and D   | Dry Pack (after          | electrical test)              |                         |   |                         |                                |                             |  |                                 |                              |  |                                 |
| or more information regarding material  | composition     | please refer to          | page 3                        |                         |   |                         |                                |                             |  |                                 |                              |  |                                 |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | on above   | Supplier Acceptance   | * Accepted                                      |   |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| sigma range of distribution unless otherwise noted). |        |                 |          |                            |                  |        |          |                 |  |
|--|--------|-----------------|----------|----------------------------|------------------|--------|----------|-----------------|--|
| Homogeneous Material                                 | Weight | Unit of Measure | Level    | Substance                  | CAS              | Exempt | Weight   | Unit of Measure |  |
| Die  | 5.84   | mg              | Supplier | Silicon (Si)               | 7440-21-3        |        | 5.84     | mg              |  |
| Die Attach   | 16.72  | mg              | Supplier | Silver (Ag)                | 7440-22-4        |        | 12.54    | mg              |  |
|  |        |                 | Supplier | Epoxy resins               | 129915-35-1      |        | 4.18     | mg              |  |
| Lead Frame   | 261.87 | mg              | Supplier | Silver (Ag)                | 7440-22-4        |        | 2.8806   | mg              |  |
|  |        |                 | Supplier | Zinc (Zn)                  | 7440-66-6        |        | 0.5237   | mg              |  |
|  |        |                 | Supplier | Iron (Fe)                  | 7439-89-6        |        | 6.8086   | mg              |  |
|  |        |                 | Supplier | Copper (Cu)                | 7440-50-8        |        | 251.6571 | mg              |  |
| Mold Compound-Black                                  | 133.38 | mg              |          | Epoxy resin                | proprietary data |        | 6.669    | mg              |  |
|  |        |                 | Supplier | Phenolic Resin             | Proprietary Data |        | 6.669    | mg              |  |
|  |        |                 | Supplier | Ortho Cresol Novolac Resin | 29690-82-2       |        | 2.6676   | mg              |  |
|  |        |                 | Supplier | Carbon Black (C)           | 1333-86-4        |        | 0.6669   | mg              |  |
|  |        |                 | Supplier | Fused Silica (SiO2)        | 60676-86-0       |        | 116.7075 | mg              |  |
| Plating  | 3.83   | mg              | Supplier | Tin (Sn)                   | 7440-31-5        |        | 3.83     | mg              |  |
| Wire Bond - Cu                                       | 0.37   | mg              | Supplier | Copper (Cu)                | 7440-50-8        |        | 0.37     | mg              |  |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3